

## MULTILAYER CERAMIC CHIP CAPACITORS









Temperature cycle: 1000 cycles

#### **♦**FEATURES

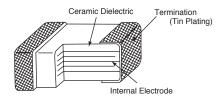
- 1. Temperature range : -55 to +150°C 2. Temperature characteristics : X8L
- 3. Exellent noise absorption.
- 4. Automotive grade (AEC-Q200)

#### **APPLICATIONS**

- 1. Noise filter for automotive equipment (ECU etc.)
- 2. Equipment used in a high temperature environment



#### **◆**CONSTRUCTION



#### **♦**RATINGS

Category Temperature Range	-55∼+150°C		
	-33 - +130 0		
Rated Voltage Range	25, 50, 100 Vdc		
3. Rated Capacitance Range	0.033∼15μF		
4. Rated Capacitance Tolerance	M(±20%)		
5. Temperature Characteristics	X8L		
6. Rated Ripple Current	See No.5 on the following table		

#### **SPECIFICATIONS**

•						
No.	Items	Specification	Test Condition			
1	Withstand Voltage	No abnormality.	250% of rated voltage shall be applied for 5 seconds.			
2	Insulation Resistance	100/C <sub>R</sub> (MΩ) or 4000(MΩ) whichever is less.	Rated voltage shall be applied for 60±5 seconds at temperature 25±2°C.			
3	Rated Capacitance	Within specified tolerance.	CR≦10μF CR>10μF		Cr>10µF	
			Temperature	25±2℃		
4	Dissipation Factor	5.0% maximum.	Frequency	1±0.1kHz	120±12Hz	
			Voltage	1±0.2Vrms	0.5±0.2Vrms	
5	Rated Ripple Current	Size code 31 32 43 55 Arms 0.3 0.5 1.0 2.0	10kHz~1MHz (sine curve) Ripple voltage Vp shall be less than the rated voltage. The surface temperature MLCC must not exceed the maximum category temperature when the ripple current is applied.			

As customer requirement, Chemi-Con has submits the test results according to AEC-Q200 for Multilayer ceramic capacitors. Please contact us for more information.



# **MULTILAYER CERAMIC CHIP CAPACITORS**



#### **SPECIFICATIONS**

No.	Items	Specification	Test Condition			
6	High Temperature Exposure (Storage)	Appearance : No abnormality. $\Delta C/C$ : $\pm 20\%$ D.F. : 10% maximum I.R. : $50/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.	Temperature : Max. category temperature ±3°C Time : 1000 ± $^{48}_{0}$ hours			
7	Temperature Cycle	Appearance : No visible damage. $\Delta C/C$ : $\pm 15\%$ D.F. : To meet the initial specification. I.R. : To meet the initial specification.	Step 1 2 3 4 (Epoxy r For 1000	Temperature (°C) Min.Category temperature ±3 Room temperature ±3 Room temperature ±3 Room temperature resin PCB t=1.6mm) O cycles	(min.) 30±3 3 max. 30±3 3 max.	
8	Biased Humidity	Appearance : No abnormality. $\Delta C/C$ : $\pm 20\%$ D.F. : 10% maximum I.R. : $25/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.	Temperature: 85°C±3°C Humidity: 80 ~ 85%RH Voltage: Rated voltage Time: 1000 ± 48 hours			
9	Operational Life	Appearance : No abnormality. $\Delta C/C$ : $\pm 20\%$ D.F. : 10% maximum I.R. : $50/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.	Temperature : Max. category temperature $\pm 3^{\circ}$ C Voltage : Rated voltage Time : $1000 \pm ^{48}_{0}$ hours			
10	Mechanical Shock	Appearance : No abnormality. $\Delta C/C$ : To meet the initial specification. D.F. : To meet the initial specification.	MIL-STD-202 Method213 Condition F Peak value: 1,500 G Normal duration: 0.5 ms Velocity change: 15.4 ft/sec (4.7m/s) Direction and time: 3 times each in X,Y, Z axis. Total 18 times			
11	Resistance to Soldering Heat	Appearance : No visible damage. $\Delta C/C$ : $\pm 15\%$ D.F. : To meet the initial specification. I.R. : To meet the initial specification.	Preheating temperature: 150±10°C Preheating time: 1 to 2 minute Solder temp.: 260±5°C Dipping Time: 10±1s			
12	ESD	Appearance: No abnormality. ΔC/C: To meet the initial specification. D.F.: To meet the initial specification. I.R.: To meet the initial specification.	AEC-Q200-002 Connection : Between terminals Direct Contact : 8kV (150pF 2000 $\Omega$ ) Times : $\pm$ 1time			
13	Solderability	Min. 75% of surface of the termination shall be covered with new solder.	Solder Pb Free Solder Temperature 245 ±5°C Dipping Time 2±0.5s			
14	Board Flex	Appearance : No visible damage. $\Delta \text{C/C}$ : $\pm 15\%$	The substrate shall be bend at rate of 1mm/s for 5 seconds.  Press Press bar  Capacitor Substrate  Bending capability*  Support  * Bending capability: 1mm or 2mm			
15	Terminal Strength (SMD)	No visible damage.		17 60	bstrate .7N 0±1 seconds	

\*CR : Rated Capacitance(µF)



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#### **STANDARD RATINGS**

Rated voltage	Rated Capacitance (µF)	Dimensions(mm)				Maximum ripple current	Part Number	Taping Quantity per reel
(Vdc)		L	W	T max.	а	(Arms)	r art Number	(pcs. / reel)
	0.33	3.2±0.3	1.6±0.2	1.8	0.7±0.2	0.3	KVF250L334M31NLT00	3,000
	0.47						KVF250L474M31NLT00	3,000
	0.68						KVF250L684M31NLT00	3,000
	1.0						KVF250L105M31NLT00	3,000
	1.5	3.2±0.4	2.5±0.3	2.6	0.7±0.2	0.5	KVF250L155M32NHT00	1,600
25	2.2						KVF250L225M32NHT00	1,600
	3.3						KVF250L335M32NHT00	1,600
	4.7	45104	00104	2.8	0.7±0.0	1.0	KVF250L475M43NHT00	800
	6.8 4.5±	4.5±0.4	3.2±0.4		0.7±0.2		KVF250L685M43NHT00	800
	10		5 O ± O 4	0.0	40+04	0.0	KVF250L106M55NHT00	800
	15	5.7±0.4	5.0±0.4	2.8	1.0±0.4	2.0	KVF250L156M55NHT00	800
	0.1	3.2±0.3	1.6±0.2	1.8			KVF500L104M31NLT00	3,000
	0.15				0.7±0.2	0.3	KVF500L154M31NLT00	3,000
	0.22						KVF500L224M31NLT00	3,000
	0.33						KVF500L334M31NLT00	3,000
	0.47						KVF500L474M31NLT00	3,000
50	0.68	00104	2.5±0.3	2.6	0.7±0.2	0.5	KVF500L684M32NLT00	1,600
50	1.0	$3.2 \pm 0.4$					KVF500L105M32NHT00	1,600
	1.5	45104	3.2±0.4	2.8	0.7±0.2	1.0	KVF500L155M43NHT00	800
	2.2	4.5±0.4					KVF500L225M43NHT00	800
	3.3		5.0±0.4	2.8		2.0	KVF500L335M55NLT00	800
	4.7 6.8	$5.7 \pm 0.4$			1.0±0.4		KVF500L475M55NHT00	800
				3.2	1		KVF500L685M55NHT00	800
	0.033	3.2±0.3	1.6±0.2	1.8	0.7±0.2	0.3	KVF101L333M31NLT00	3,000
	0.047						KVF101L473M31NLT00	3,000
	0.068						KVF101L683M31NLT00	3,000
	0.1						KVF101L104M31NLT00	3,000
	0.15	3.2±0.4	2.5±0.3	2.6	0.7±0.2	0.5	KVF101L154M32NLT00	1,600
100	0.22						KVF101L224M32NLT00	1,600
	0.33						KVF101L334M32NLT00	1,600
	0.47	45+04	2.0 + 0.4	2.8	07400	1.0	KVF101L474M43NLT00	800
	0.68	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		0.7±0.2	1.0	KVF101L684M43NLT00	800	
	1.0	50101	0.0	10404	0.0	KVF101L105M55NLT00	800	
	1.5	5.7±0.4	$5.0 \pm 0.4$	2.8	1.0±0.4	2.0	KVF101L155M55NLT00	800

X Please consult with us when you consider the rating other than a standard table.

#### 

**◆PART NUMBERING SYSTEM** 

Nominal Capacitance code
Temperature characteristics code
Rated voltage code
Series code
Category

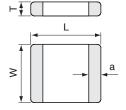
#### Size Code Code JIS ΕIΑ 1206 31 3216 32 3225 1210 4532 1812 43 55 5750 2220

7563

3025

Size Code

76



**◆DIMENSIONS** 

Please refer to "Part Numbering System" of the beginning of a catalog for the details.

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NMC0402X7R153K16TRPF NMC0603NPO330G50TRPF NMC0603NPO331F50TRPF NMC0603X5R475M6.3TRPF

NMC0805NPO220J100TRPF NMC0805NPO270J50TRPF NMC0805NPO681F50TRPF NMC0805NPO820J50TRPF

NMC0805X7R224K25TRPF NMC1206X7R102K50TRPF NMC1210Y5V105Z50TRPLPF NMC-H0805X7R472K250TRPF NMC-L0402NPO7R0C50TRPF NMC-L0603NPO2R2B50TRPF NMC-Q0402NPO8R2D200TRPF C1206C101J1GAC C1608C0G2A221J

C1608X7R1E334K C2012C0G2A472J 2220J2K00562KXT KHC201E225M76N0T00 1812J2K00332KXT CCR06CG153FSV

CDR14BP471CJUR CDR31BX103AKWR CDR33BX683AKUS CGA2B2C0G1H010C CGA2B2C0G1H040C CGA2B2C0G1H050C

CGA2B2C0G1H060D CGA2B2C0G1H070D CGA2B2C0G1H120J CGA2B2C0G1H151J CGA2B2C0G1H1R5C CGA2B2C0G1H2R2C

CGA2B2C0G1H390J CGA2B2C0G1H391J CGA2B2C0G1H3R3C CGA2B2C0G1H680J CGA2B2C0G1H6R8D CGA2B2C0G1H820J